MPC5777C Software Initialization and Optimization

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1 Introduction
This application note describes a recommended software initialization procedure for the MPC5777C 32-bit Power Architecture® automotive microcontroller. This covers starting both Power Architecture cores, memory management units (MMU), clock frequency (PLL), watchdog timers, flash memory controller, and internal static RAM. Recommended configuration settings for these modules will be given for the purpose of optimizing system performance.

The MPC5777C is a high-performance 32-bit Power Architecture Microcontroller for powertrain applications. The three e200z7 host processor cores, two of which run in lockstep, of the MPC5777C are compatible with the Power Architecture Book E architecture. They are 100% user-mode compatible (with floating point library) with the classic PowerPC instruction set. The Book E architecture has enhancements that improve the architecture’s fit in embedded applications. In addition to the standard and VLE Power Architecture instruction sets, both cores have additional instruction support for digital signal processing (DSP).

The MPC5777C has two levels of memory hierarchy; separate 16 K instruction and 16 K data caches for each of the two cores and 512 KB of on-chip SRAM including 48 KB standby RAM. 8 MB of internal flash memory is provided. An external bus interface is also available for special packaged parts to support application development and calibration.

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2 Overview

There are several options to consider when discussing the structure of our embedded software application. The first is how it will execute. The application can be stored in internal flash memory or it can be downloaded from an external device, such as a debugger, or via a serial communications link. This affects certain steps in the initialization process and where applicable, this will be noted. Another option is choosing Variable Length Encoding instructions (VLE) vs. PowerPC Book E instructions. The assembly code examples shown in this application note will use VLE mnemonics and syntax, but can easily be translated into the Book E variant.
3 Startup code

The first part of the initialization procedure executes on the primary core (core 0) from the reset vector or program entry point and performs the minimal setup needed to prepare for C code execution. Another goal of this stage is to optimize the startup procedure’s execution time. This involves taking certain initialization steps in a particular order:

1. Reset configuration and watchdog
2. Program PLL
3. Configure memory management unit
4. Enable instruction and data caches
5. Initialize SRAM
6. Initialize C runtime environment
7. Start core 1

Steps 1-6 are performed first by core 0. Core 1 will not be started until execution enters the main C routine. It is possible to start core 1 slightly earlier but core 0 should at least complete PLL and SRAM initialization first.

3.1 Reset configuration and watchdog

There are several ways to begin software execution after device reset. These are controlled by the Boot Assist Module (BAM).

- Boot from internal flash
- Serial boot via SCI or CAN interface with optional baud-rate detection
- Boot from a memory connected to the MCU development bus (EBI) with multiplexed or separate address and data lines (not available on all packages)

When using a hardware debugger connected via the JTAG or Nexus ports, the BAM can be bypassed. The debugger can download software to RAM via the debug interface and specify a start location for execution. In this case, much of the low-level device initialization is accomplished by the debugger using configuration scripts.

This application note will focus on the internal flash boot case because it performs all initialization tasks either in the BAM or explicitly in the application code. During any power-on, external, or internal reset event, except for software reset, the BAM begins by searching for a valid Reset Configuration Half Word (RCHW) in internal flash memory at one of the following pre-defined addresses.

<table>
<thead>
<tr>
<th>Priority</th>
<th>Address</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0x0080_0000</td>
</tr>
<tr>
<td>1</td>
<td>0x0002_0000</td>
</tr>
<tr>
<td>2</td>
<td>0x0003_0000</td>
</tr>
<tr>
<td>3</td>
<td>0x0000_0000</td>
</tr>
<tr>
<td>4</td>
<td>0x0001_0000</td>
</tr>
</tbody>
</table>

The RCHW is a collection of control bits that specify a minimal MCU configuration after reset. If a valid RCHW is not found, the BAM will attempt a serial boot. Here is the format for the RCHW:
Table 2. Reset configuration half word

<table>
<thead>
<tr>
<th>0</th>
<th>1</th>
<th>2</th>
<th>3</th>
<th>4</th>
<th>5</th>
<th>6</th>
<th>7</th>
<th>8</th>
<th>9</th>
<th>10</th>
<th>11</th>
<th>12</th>
<th>13</th>
<th>14</th>
<th>15</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>SWT</td>
<td>WTE</td>
<td>PS0</td>
<td>VLE</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Reserved</td>
<td>x</td>
<td>x</td>
<td>x</td>
<td>x</td>
<td>0</td>
<td>1</td>
<td>0</td>
<td>1</td>
<td>1</td>
<td>0</td>
<td>1</td>
<td>0</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

1. x = User-defined

Where:
- SWT = Software watchdog timer enable
- WTE = MCU core watchdog timer enable
- PS0 = Port size
- VLE = VLE Code Indicator

See the MPC5777C reference manual for more details on these bit-field definitions.

The RCHW occupies the most significant 16 bits of the first 32-bit internal memory word at the boot location. The next 32 bits contain the boot vector address. After applying the RCHW, the BAM will branch to this boot vector. During software initialization, reserve space for both of these 32-bit locations in the linker directive file as follows:

```plaintext
MEMORY
{
    flash_rcw : org = FLASH_BASE_ADDR,   len = 0x8
        ...
}

SECTIONS
{
    .rcw              : {}   > flash_rcw
        ...
}
```

In the initialization code file, these two locations are generated with a valid RCHW encoding and the start address symbol for code entry point

```plaintext
.sect .rcw
    .LONG 0x015A0000    # RCHW
    .LONG _start        # Code entry point
```

In the example above, the core (WTE) and software (SWT) watchdog timers are both disabled. These can operate independently, but it is common to use just one or the other in an application. When debugging, the RCHW is not applied when the BAM does not execute, so the debugger must disable these timers so that they do not interfere with application debug sessions. Disabling the core watchdog is necessary, because it cannot be disabled by software once it is enabled. The software watchdog starts out in an unlocked state, so the control register is still writable. If desired, the enable bit can be cleared to prevent watchdog operation during a debug session, if the debug tool does not handle this with its own configuration scripts.

**NOTE**

If either watchdog timer is enabled, there may be points within the initialization procedure that require watchdog service, depending on the timeout period of the watchdog.
3.2 Programming the PCS

The Progressive Clock Switch (PCS) module is used to prevent sudden voltage drops and overshoots when the system clock frequency is switched from one clock source to another. The PCS module can be programmed for both ramp-up and ramp-down and automatically monitors changes of the system clock source to trigger the progressive clock switching feature. Since the PCS assumes that the Internal Reference Clock (IRC) is the lowest clock frequency of the device, the user should not use PCS when switching to or from a frequency less than the IRC frequency.

The PCS module can detect if the system clock source is changing to and from the XOSC, PLL1, and PLL0. A set of three registers need to be programmed for each of the system clock sources that will be used. These registers include the PCS Divider Change Register (PCS_DIVCn), PCS Divider End Register (PCS_DIVEn), and PCS Divider Start Register (PCS_DIVSn). PCS_DIVC1, PCS_DIVE1, and PCS_DIVS1 need to be programmed if to configure the PCS module for XOSC. There also exists a single PCS Switch Duration Register (PCS_SDUR) that applies to all three of the clock sources.

NOTE
To use the PCS module, SIU_SYSDIV[PCSEN] must be set to 1 before changing SIU_SYSDIV[SYSCLKSEL] to ensure correct behavior. The PCS module will not function correctly if SIU_SYSDIV[PCSEN] is written to 1 in the same write as a change to SIU_SYSDIV[SYSCLKSEL].

To determine the values for these registers, see the PCS section in the reference manual.

The following example configures the PCS module for PLL1 given PLL1 will operate at 264 MHz, maximum allowable current change (mA/μs), and step duration (μs) of 1. This values used in the code below are just an example. The user should change these values based on the user's power supply. See the MPC5777C reference manual for more details on configuring the PCS.

```assembly
#****************************
# configure PCS
#****************************

# Configure PCS Switch Duration
# SDUR = 0x10
  e_lis   r3,0xFFE7
  e_lis   r4,0x1000
  e_stw   r4,0x700(r3)

# Configure PLL1 Divider Change Register
# INIT = 0x4DF
# RATE = 0x30
  e_lis   r3,0xFFE7
  e_lis   r4,0x04DF
  e_or2i  r4,0x0030
  e_stw   r4,0x710(r3)

# Configure PLL1 Divider End Register
# DIVE = 0x4073
  e_lis   r3,0xFFE7
  e_li    r4,0x4073
  e_stw   r4,0x714(r3)

# Configure PLL1 Divider Start Register
# DIVS = 0x45B7
  e_lis   r3,0xFFE7
  e_li    r4,0x45B7
  e_stw   r4,0x718(r3)
```
3.3 Programming the PLL

The PLL module contains two clock domains coming from separate PLLs, PLL0 and PLL1. PLL1 feeds the system clock of the cores, cross-bar switch, peripheral bridges, memories, debug logic, and the memory mapped portion of peripherals. PLL0 feeds the state machines and protocol engines of communication and timer peripheral modules. PLL1 can be configured to be frequency modulated to reduce electromagnetic emissions. PLL0 is intended to provide an accurate reference clock for the peripheral timer and communication functions and cannot tolerate frequency modulation. The two outputs of PLL0 are PHI and PHI1. The PHI output clock drives various peripheral clocks and the system clock when PLL1 is not locked or active. The PHI1 output clock provides one of the input references for PLL1.

The user can configure both PLLs by writing to the Dual PLL Digital Interface (PLLDIG) registers. In normal operation, the following equations can be used to calculate the programming values for the two PLLs:

\[
F_{\text{pll0_phi}} = F_{\text{pll0_ref}} \times \text{PLL0DV[MFD]} / ( \text{PLL0DV[PREDIV]} \times \text{PLL0DV[RFDPHI]} )
\]

\[
F_{\text{pll0_phi1}} = F_{\text{pll0_ref}} \times \text{PLL0DV[MFD]} / ( \text{PLL0DV[PREDIV]} \times \text{PLL0DV[RFDPHI1]} )
\]

\[
F_{\text{pll1_phi}} = F_{\text{pll1_ref}} \times \text{PLL1DV[MFD]} / ( 2 \times \text{PLL1DV[RFDPHI]} )
\]

Where:

- \(F_{\text{pll0_phi}}\) = PLL0 PHI output frequency
- \(F_{\text{pll0_phi1}}\) = PLL0 PHI1 output frequency
- \(F_{\text{pll1_phi}}\) = PLL1 PHI output frequency
- \(\text{PLL0DV[MFD]}\) = PLL0 Loop multiplication factor divider
- \(\text{PLL0DV[PREDIV]}\) = PLL0 Input clock predivider
- \(\text{PLL0DV[RFDPHI]}\) = PLL0 PHI reduced frequency divider
- \(\text{PLL0DV[RFDPHI1]}\) = PLL0 PHI1 reduced frequency divider
- \(\text{PLL1DV[MFD]}\) = PLL1 Loop multiplication factor divider
- \(\text{PLL1DV[RFDPHI]}\) = PLL1 PHI reduced frequency divider

### Table 3. Example PLL settings

<table>
<thead>
<tr>
<th>(F_{\text{pll0_phi}})</th>
<th>(F_{\text{pll0_phi1}})</th>
<th>(F_{\text{pll1_phi}})</th>
<th>(F_{\text{pll0_ref}})</th>
<th>(\text{PLL0DV[MFD]})</th>
<th>(\text{PLL0DV[PREDIV]})</th>
<th>(\text{PLL0DV[RFDPHI]})</th>
<th>(\text{PLL0DV[RFDPHI1]})</th>
<th>(\text{PLL1DV[MFD]})</th>
<th>(\text{PLL1DV[RFDPHI]})</th>
</tr>
</thead>
<tbody>
<tr>
<td>192 MHz</td>
<td>48 MHz</td>
<td>264 MHz</td>
<td>40 MHz</td>
<td>72</td>
<td>5</td>
<td>3</td>
<td>12</td>
<td>22</td>
<td>2</td>
</tr>
<tr>
<td>200 MHz</td>
<td>50 MHz</td>
<td>262.5 MHz</td>
<td>40 MHz</td>
<td>40</td>
<td>4</td>
<td>2</td>
<td>8</td>
<td>21</td>
<td>2</td>
</tr>
</tbody>
</table>

The following example sets up PLL0 to produce a 192 MHz peripheral clock and PLL1 to produce a 264 MHz system clock assuming a 40 MHz reference crystal.

```bash
#****************************
# configure PLL0 to 192 MHz (40 MHz XOSC reference)
# configure PLL1 to 264 MHz (48 MHz PLL0 PHI1 output reference)
# progressive clock switching enabled
#****************************
#
# Disable PLL0
#   e_lis  r3,0xFFE7
#   e_or2i r3,0x4000
#   e_l1   r4,0
#   e_stw  r4,0(r3)
# Disable PLL1
#   e_stw  r4,0x20(r3)
#
# Select XOSC as PLL0 source
# Select PHI1 output of PLL0 as PLL1 source
#   e_lis  r3,0xC3F9
#   e_lis  r4,0x0400
#   e_or2i r4,0x0010
#   e_stw  r4,0x9A0(r3)
```
# Program PLL0
# RPDPHI1 = 0x0C
# RPDPHI = 0x03
# PREDIV = 0x5
# MFD = 0x48
  e_lis r3,0xFFE7
  e_or2i r3,0x4000
  e_lis r4,0x5003
  e_or2i r4,0x5048
  e_stw r4,0x8(r3)

# Wait for stable XOSC
xosc_wait:
  e_lis r3,0xC3F9
  e_lwz r4,0xC(r3)   # load SIU_RSR
  e_andi r4,0x80
  se_beq xosc_wait

# Turn on PLL0 and wait for lock
  e_lis r3,0xFFE7
  e_or2i r3,0x4000
  e_li r4,0x0300
  e_stw r4,0(r3)

wait_for_pll0:
  e_lwz r4,0x4(r3)   # load PLLDIG_PLL0SR
  e_andi r4,0x4
  se_beq wait_for_pll0

# Program PLL1
# RPDPHI = 0x02
# MFD = 0x16
  e_lis r3,0x0002
  e_or2i r3,0x0016
  e_stw r3,0x28(r3)

# Turn on PLL1 and wait for lock
  e_li r4,0x0300
  e_stw r4,0x20(r3)

wait_for_pll1:
  e_lwz r4,0x24(r3)
  e_andi r4,0x4
  se_beq wait_for_pll1

At this point, though the PLL is locked on the desired clock rate, the device is still being clocked by the internal RC oscillator. Select the PLL1 as the new system clock source and other clock dividers used in this example.

******************************************************************************
# Select clock dividers and sources
# PLL0 ref = XOSX
# PLL1 ref = PLL0 PHI1
# PERCLKSEL = PLL1
# PERDIV = Divide-by-2
# MCANSEL = XOSC
# SYCLKSEL = PLL1
# ETPUDIV = Divide-by-1
# SYCLKDIV = Divide-by-1
# PCS = Enabled
******************************************************************************
  e_lis r3,0xC3F9
  e_lis r4,0x5000
  e_or2i r4,0x2111
  e_stw r4,0x9A0(r3)
3.4 Memory management unit (MMU)

The BAM includes a default setup for the MMU. The first thing the BAM program does is configure the MMU to allow access to all MCU internal resources. Below is an example of MMU configuration that enables Variable-Length Encoding, alters some default Table Lookup Buffer (TLB) sizes, and adds an entry for stack-in cache. The resulting MMU table is as follows:

<table>
<thead>
<tr>
<th>TLB</th>
<th>Space</th>
<th>Address</th>
<th>Size</th>
<th>Attributes</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>Peripheral bridge B</td>
<td>0xFFE0_0000</td>
<td>2 MB</td>
<td>Cache inhibit, Guarded</td>
</tr>
<tr>
<td>1</td>
<td>Flash</td>
<td>0x0000_0000</td>
<td>8 MB</td>
<td>VLE</td>
</tr>
<tr>
<td>2</td>
<td>External bus</td>
<td>0x2000_0000</td>
<td>16 MB</td>
<td>VLE</td>
</tr>
<tr>
<td>3</td>
<td>SRAM</td>
<td>0x4000_0000</td>
<td>512 KB</td>
<td>Write-through cache, VLE</td>
</tr>
<tr>
<td>4</td>
<td>Peripheral bridge A</td>
<td>0xC3E0_0000</td>
<td>2 MB</td>
<td>Cache inhibit, Guarded</td>
</tr>
<tr>
<td>5</td>
<td>Stack</td>
<td>0x4008_0000</td>
<td>8 KB</td>
<td>-</td>
</tr>
</tbody>
</table>

The following code configures the MMU with the parameters from Table 4.

```assembly
#TLB1 = internal flash @ 0x0000_0000, VLE
  e.lis r3,0x1001
  mtspr mas0,r3
  e.lis r3,0xC000
  e.or2i r3,0x0700
  mtspr mas1,r3
  e.lis r3,0x0000
  e.or2i r3,0x0020
  mtspr mas2,r3
  e.lis r3,0x0000
  e.or2i r3,0x003F
  mtspr mas3,r3
  msync # Synchronize in case running from flash
  tlbwe
  se.isync # Synchronize in case running from flash

#TLB3 = internal SRAM @ 0x4000_0000, VLE, Write-Through Cache
  e.lis r3,0x1003
  mtspr mas0,r3
  e.lis r3,0xC000
  e.or2i 3,0x0480
  mtspr mas1,r3
  e.lis r3,0x4000
  e.or2i 3,0x0030
  mtspr mas2,r3
  e.lis r3,0x4000
  e.or2i 3,0x003F
  mtspr mas3,r3
  msync # Synchronize in case running from SRAM
  tlbwe
  se.isync # Synchronize in case running from SRAM

#TLB0 = pbridgeB @ 0xFFE0_0000, Cache inhibited, Guarded
  e.lis r3,0x1000
  mtspr mas0,r3
  e.lis r3,0xC000
  e.or2i r3,0x0580
  mtspr mas1,r3
  e.lis r3,0xFFE0
  e.or2i r3,0x000A
  mtspr mas2,r3
  e.lis r3,0xFFE0
```

Startup code

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e_or2i r3,0x003F
mtspr mas3,r3
tlbwe

#TLB2 = external bus @ 0x2000_0000, VLE
    e_lis   r3,0x1002
    mtspr   mas0,r3
e_lis   r3,0xC000
    e_or2i  r3,0x0700
    mtspr   mas1,r3
e_lis   r3,0x2000
    e_or2i  r3,0x0020
    mtspr   mas2,r3
e_lis   r3,0x0000
    e_or2i  r3,0x003F
    mtspr   mas3,r3
tlbwe

#TLB4 = pbridgeA @ 0xC3E0_0000, Cache inhibited, Guarded
    e_lis   r3,0x1004
    mtspr   mas0,r3
e_lis   r3,0xC000
    e_or2i  r3,0x0580
    mtspr   mas1,r3
e_lis   r3,0xC3E0
    e_or2i  r3,0x000A
    mtspr   mas2,r3
e_lis   r3,0xC3E0
    e_or2i  r3,0x003F
    mtspr   mas3,r3
tlbwe

#TLB5 = 4k stack for each core (will be locked in cache)
Note that in this example, tlbwe is preceded by msync and followed by se_isync for TLB1 and TLB3. These synchronization steps are taken in case the code being executed is from the region being modified.

3.5 Enable caches

The core instruction and data caches are enabled through the L1 Cache Control and Status Registers 0 & 1 (L1CSR0 and L1CSR1). The instruction cache is invalidated and enabled by setting the ICINV and ICE bits in L1CSR1. The data cache is enabled by setting DCINV and DCE in L1CSR0. The cache invalidate operation takes some time and can be interrupted or aborted. Because the cache invalidate operation occurs, in the code example below, during the boot-up procedure, this operation will not be interrupted or aborted.
The following code represents a more robust cache enable routine that may be used elsewhere in the application, if desired. This code checks to ensure the invalidation has successfully completed and if not, retries the operation before enabling the cache. This code may be used with interrupts enabled, provided that those interrupts are properly handled and cleared. If the invalidate operation cannot complete without being interrupted due to a heavy interrupt load in the system, it is better to disable interrupts first.

```
cfg_ICACHE:
    #--------------------------------------------#
    # Invalidate Instruction Cache - Set ICINV   #
    # bit in L1CSR1 Register                     #
    #--------------------------------------------#
    e_lis   r5, 0x0000
    e_or2i  r5, 0x0002
    mtspr   l1csr1,r5
    se_isync

    #--------------------------------------------#
    # Mask out ICINV and ICABT to see if         #
    # invalidation is complete (i.e. ICINV=0,    #
    # ICABT=0)                                   #
    #--------------------------------------------#
label_ICINV_check:
    #--------------------------------------------#
    # Load Registers with Masks:                 #
    # Load ICINV mask into R4                    #
    # Load ICABT mask into R6                    #
    # Load ICABT clear mask into R7              #
    #--------------------------------------------#
    e_lis   r4, 0x0000
    e_or2i  r4, 0x0002
    e_lis   r6, 0x0000
    e_or2i  r6, 0x0002
    e_lis   r7, 0xFFFF
    e_or2i  r7, 0xFFFB

CHECK_ICINV:
    #--------------------------------------------#
    # Read L1CSR1 register, store in r3          #
    #--------------------------------------------#
    mfspr   r3, l1csr1
    #--------------------------------------------#
    # check for an ABORT of the cache invalidate #
    # operation                                  #
    #--------------------------------------------#
    se_and. r6, r3
    se_beq  NO_ABORT
    #--------------------------------------------#
    # If abort detected, clear ICABT bit and     #
    # re-run invalidation                        #
    #--------------------------------------------#
    se_and. r7, r3
    mtspr   l1csr1, r7
    se_isync
    se_b    cfg_ICACHE

NO_ABORT:
    #--------------------------------------------#
    # Check that invalidation has completed -    #
    # (ICINV=0). Branch if invalidation not      #
    # complete.                                  #
    #--------------------------------------------#
    se_and. r4, r3
    se_bne  CHECK_ICINV
```
Enable the ICache by performing a read/modify/write of the ICE bit in the L1CSR1 register.

```
mfspr r5, l1csr1
e_or2is r5, 0x0000
e_or2i  r5, 0x0001  # Store L1CSR1 value to R5 (ICE=1)
mtspr l1csr1, r5    # Write R5 to L1CSR1 register
se_isync
```

## 3.6 SRAM initialization

The internal SRAM features Error Correcting Code (ECC). Because these ECC bits can contain random data after the device is turned on, all SRAM locations must be initialized before being read by application code. Initialization is done by executing 64-bit writes to the entire SRAM block. The value written does not matter at this point, so the Store Multiple Word instruction will be used to write 32 general-purpose registers with each loop iteration. The following code initializes 512 KB of SRAM.

```
# Store number of 128Byte (32GPRs) segments in Counter
 e_lis r5, _SRAM_SIZE@h   # Initialize r5 to size of SRAM (Bytes)
 e_or2i r5, _SRAM_SIZE@l
 e_srwi r5, r5, 0x7        # Divide SRAM size by 128
 mtcctr r5                 # Move to counter for use with "bdnz"

# Base Address of the internal SRAM
 e_lis r5, _SRAM_BASE_ADDR@h
 e_or2i r5, _SRAM_BASE_ADDR@l

# Fill SRAM with writes of 32GPRs
sram_loop:
 e_stmw r0,0(r5)            # Write all 32 registers to SRAM
 e_addi r5,r5,128           # Increment the RAM pointer to next 128bytes
 e_bdnz sram_loop           # Loop for all of SRAM
```

## 3.7 C runtime register setup

The Power Architecture Enhanced Application Binary Interface (EABI) specifies certain general purpose registers as having special meaning for C code execution. At this point in the initialization code, the stack pointer, small data, and small data 2 base pointers are set up. EABI-conformant C compilers will generate code that makes use of these pointers later on.

```
e_lis r1, __SP_INIT@h     # Initialize stack pointer r1 to
e_or2i r1, __SP_INIT@l

 e_lis r13, _SDA_BASE_@h   # Initialize r13 to sdata base
e_or2i r13, _SDA_BASE_@l   # (provided by linker).

 e_lis r2, _SDA2_BASE_@h   # Initialize r2 to sdata2 base
e_or2i r2, _SDA2_BASE_@l   # (provided by linker).
```

As noted in the comments above, these values are defined in the linker command file for this project.

```
__DATA_SRAM_ADDR   = ADDR(.data);
__SDATA_SRAM_ADDR  = ADDR(.sdata);
__DATA_SIZE        = SIZEOF(.data);
```
These values in the internal flash boot case will be used to copy initialized data from flash to SRAM, but first the SRAM must be initialized.

This runtime setup procedure may vary depending on the compiler. Consult your compiler's documentation. There may also be additional setup required for initializing the C standard library.

### 3.8 Copy initialized data

When booting from flash, the program image stored in flash will contain the various data segments created by the C compiler and linker. Initialized read-write data must be copied from read-only flash to read-writable SRAM before branching to the C main routine.

The following example assumes the initialized data values are stored uncompressed in the flash. Some compilers compress this data to save space in the flash image. The example code to this application note invokes the compiler-dependent _start routine to accomplish the C runtime setup and data copy for core 0. This example is provided as a reference.

```
##--------- Initialized Data - ".data" --------------------------------------
DATACOPY:
  e_lis       r9, __DATA_SIZE@ha  # Load upper SRAM load size
  e_or2i      r9, __DATA_SIZE@l  # Load lower SRAM load size into R9
  e_cmp16i    r9,0                # Compare to see if equal to 0
  se_beq      SDATACOPY          # Exit cfg_ROMCPY if size is zero
  mtctr       r9                  # Store no. of bytes to be moved in counter
  e_lis       r10, __DATA_ROM_ADDR@h # Load address of first SRAM load into R10
  e_or2i      r10, __DATA_ROM_ADDR@l # Load lower address of SRAM load into R10
  se_subi     r10, 1              # Decrement address
  e_lis       r5, __DATA_SRAM_ADDR@h # Load upper SRAM address into R5
  e_or2i      r5, __DATA_SRAM_ADDR@l # Load lower SRAM address into R5
  se_subi     r5, r5, 1           # Decrement address

DATACPYLOOP:
  e_lbzu      r4, 1(r10)          # Load data byte at R10 into R4
  e_stbu      r4, 1(r5)           # Store R4 data byte into SRAM at R5
  e_bdnz      DATACPYLOOP         # Branch if more bytes to load from ROM

##--------- Small Initialised Data - ".sdata" --------------------------------------
SDATACOPY:
  e_lis       r9, __SDATA_SIZE@ha  # Load upper SRAM load size
  e_or2i      r9, __SDATA_SIZE@l  # Load lower SRAM load size into R9
  e_cmp16i    r9,0                # Compare to see if equal to 0
  e_beq       ROMCPYEND           # Exit cfg_ROMCPY if size is zero
  mtctr       r9                  # Store no. of bytes to be moved in counter
  e_lis       r10, __SDATA_ROM_ADDR@h # Load address of first SRAM load into R10
  e_or2i      r10, __SDATA_ROM_ADDR@l # Load lower address of SRAM load into R10
  e_subi      r10, r10, 1         # Decrement address
  e_lis       r5, __SDATA_SRAM_ADDR@h # Load upper SRAM address into R5
  e_or2i      r5, __SDATA_SRAM_ADDR@l # Load lower SRAM address into R5
  e_subi      r5, r5, 1           # Decrement address

SDATACPYLOOP:
  e_lbzu      r4, 1(r10)          # Load data byte at R10 into R4
  e_stbu      r4, 1(r5)           # Store R4 data byte into SRAM at R5
  e_bdnz      SDATACPYLOOP        # Branch if more bytes to load from ROM

ROMCPYEND:
```

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3.9 Start core 1

While core 0 begins execution immediately after device reset, core 1 remains held in reset. Its reset input is controlled by the Halt register (SIU_HLT) and the Core 1 Reset Vector register (SIU_RSTVEC1). Clearing either the core 1 HLT bit in SIU_HLT or the RST bit in SIU_RSTVEC1 will de-assert reset to core 1 and allow it to begin execution. When core 1 comes out of reset, it begins executing code at the address specified in the RSTVEC field of register SIU_RSTVEC1. By default, this field points to the address 0xFFFF_FFFC, which is the address of the Boot Assist Module (BAM). If SIU_RSTVEC also contains a field to specify whether this start code should be executed in Book E Power Architecture or Variable Length Encoding (VLE) format. If the user wants to supply a different start address, the RSTVEC field must be set before clearing either the HLT or RST bits.

The following example main C routine is used by both cores. It first checks the core’s Processor ID Register (PIR) to determine which core is executing the code. PIR will read 0 for core 0 and 1 for core 1. The main routine then branches to core-specific code depending upon the value in PIR. Core 0 begins by starting core 1 and then enters an infinite loop to toggle a GPIO. Core 1 simply toggles a different GPIO.

```c
#define RSTVEC_VLE 1
#define RSTVEC_RESET 0x2
#define RSTVEC_RST_MASK 0xFFFFFFFC
extern unsigned long __start;

int main (void)
{
    int pid;
    asm ("li r0, 0x4000");
    asm ("mthid0 r0"); /* enable TB and decrementer */
    pid = __MFSPR(286);
    if (pid == 0)
    {
        volatile int i;
        SIU.PCR[144].R = ALT0 | OBE; /* PA=0, OBE=1 for GPIO[0] PA[1] */
        /* Start Core 1 in VLE mode */
        SIU.RSTVEC1.R = ((unsigned long)&__start & RSTVEC_RST_MASK) | RSTVEC_VLE;
        while (1)/* loop forever (core 0) */
        {
            i++;
            if (i % 1000000 == 0)
            {
                SIU.GPDO[144].R ^= 1;
            }
        }
    } else {
        volatile int i;
        SIU.PCR[113].R = ALT0 | OBE; /* PA=0, OBE=1 for GPIO[0] PA[0] */
        while (1)/* loop forever (core 1) */
        {

```

1. While it is possible to start core 1 from the Boot Assist Monitor address, it is more efficient to supply the start routine address in RSTVEC even if it is the same address as used by core 0. Doing so avoids having BAM perform the Reset Configuration Half-Word search in flash again as well as the setup of the MMU which must be updated anyway in the initialization routine. As noted above, if you do not want the BAM to be executed again for core 1 then you must set a new start address value in the RSTVEC field of register SIU_RSTVEC1 before clearing either the core 1 HLT or RST bits.
Because core 1 has been pointed at the same startup procedure as core 0, it is necessary to add similar PIR checks and branches to skip initialization tasks that do not need to be repeated for core 1, such as PLL configuration and SRAM ECC initialization. For example:

```
mfpir r5       # Check core id
se_cmpi r5,0
bne pll_end    # Skip pll init if this is core 1
```

Another important consideration is MMU setup. By default, core 1 will have a single MMU entry out of reset. TLB0 will allow access to the 4 K address space beginning at the start address provided in RSTVEC. The startup code must program the remaining MMU table entries to cover all other address spaces, expanding TLB0 as necessary, or using a different entry to cover additional code execution space.

## 4 MCU optimization

In this section, the following areas for potential optimization will be discussed:

- Wait states, prefetch, and BIU settings for the flash controller
- Branch target buffer
- Crossbar switch

Other areas of optimization to consider but will not be discussed in this section include:

- using an optimizing compiler.
- making use of the signal processing extension (SPE1.1) instruction support for digital signal processing (DSP).
- using the Enhanced Time Processing Unit (eTPU) for timing.
- making use of the floating point unit (FPU) for floating point calculations.
- enabling the instruction and data caches.

### 4.1 Flash optimization

The on-chip flash array controller comes out of reset with fail-safe settings. Wait states are set to maximum and performance features like prefetch, read buffering, and pipelining are disabled. These settings can typically be optimized based on the operating frequency, using the information specified in the MPC5777C data sheet. The following code can be modified to select the appropriate value for the flash array’s Platform Flash Configuration Registers (PFCRn).

The following example selects the 132 MHz operating settings which accomplish the following optimizations:

- Enable instruction prefetch for both cores on buffer hits and misses
- Enable read buffer
- Reduce read wait states to 3
- Pipelined access to flash is disabled and one wait state is inserted before a subsequent access can be initiated

Because, in this example, the program is executing from flash memory, the user needs to load instructions to perform the update of PFCR1 and PFCR2 into SRAM and temporarily execute from there.
# Optimize Flash
#
# Code is copied to RAM first, then executed, to avoid executing code from flash
# while wait states are changing.

```
se_b copy_to_ram
```

# settings for 132MHz platform
#
# PFCR1 = 0x00018317
# P0_M8PFE = 0b0  (Core 0 Nexus master pre-fetch disabled)
# P0_M0PFE = 0b1  (Core 0 master pre-fetch enabled)
# P0_MxPFE = 0b0  (All other masters N/A port 0, disable)
# APC = 0b100    (APC disabled and 1 wait state added per Errata 7422)
# RWSC = 0b011   (3 additional hold cycles)
# P0_DPFEN = 0b0  (Port0 data pre-fetch disabled)
# P0_IPFEN = 0b1  (Port0 instruction pre-fetch enabled)
# P0_PFLIM = 0b1x (prefetch on miss or hit)
# P0_BFEN = 0b1   (read line buffer enabled)
#
# PFCR2 = 0x00020017
# P1_MxPFE = 0b0  (All other masters N/A port 1, disable)
# P1_M9PFE = 0b0  (Core 1 Nexus master pre-fetch disabled)
# P1_M8PFE = 0b0  (Core 0 Nexus pre-fetch N/A port 1, disable)
# P1_M6PFE = 0b0  (SIPI master pre-fetch disabled)
# P1_M5PFE = 0b0  (eDMA_B master pre-fetch disabled)
# P1_M4PFE = 0b0  (eDMA_A master pre-fetch disabled)
# P1_M3PFE = 0b0  (CSE master pre-fetch disabled)
# P1_M2PFE = 0b0  (FEC master pre-fetch disabled)
# P1_M1PFE = 0b1  (Core 1 master pre-fetch enabled)
# P1_M0PFE = 0b0  (Core 0 master pre-fetch N/A port 1, disable)
# P1_DPFEN = 0b0  (data pre-fetch disabled)
# P1_IPFEN = 0b1  (instruction pre-fetch enabled)
# P1_PFLIM = 0b1x (prefetch on miss or hit)
# P1_BFEN = 0b1   (read line buffer enabled)
#
```

```
flash_opt:
e_lis  r3,0x0001
_e_or2i r3,0x8317
_e_lis  r4,0xFFF6
_e_or2i r4,0x8000
_e_stw r3,0(r4)  # PFCR1
_e_lis  r3,0x0002
_e_or2i r3,0x0017
_e_stw r3,4(r4)  # PFCR2
se_isync
msync
se_blr
```

copy_to_ram:
```
e_lis  r3,flash_opt@h
_e_or2i r3,flash_opt@l
_e_lis  r4,copy_to_ram@h
_e_or2i r4,copy_to_ram@l
subf  r4,r3,r4
se_mtctr r4
_e_lis r5,0x4000
se_mtlr r5
```
copy:
```
e_lbz r6,0(r3)
e_stb r6,0(r5)
e_addi r3,r3,1
_e_addi r5,r5,1
_e_bdnz copy
se_isync
msync
se_blrl
```
4.2 Branch target buffer

The MPC5777C Power Architecture cores feature a branch prediction optimization which can be enabled to improve overall performance by storing the results of branches and using those results to predict the direction of future branches at the same location. To initialize the branch target buffer, it is necessary to flush invalidate the buffer and enable branch prediction. This can be accomplished with a single write to the Branch Unit Control and Status Register (BUCSR) in each core.

```c
#--------------------------------------------#
# Flush and Enable BTB - Set BBFI and BPEN   #
#--------------------------------------------#
e_li    r3, 0x0201
mtspr   1013, r3
se_isync
```

If the application modifies instruction code in memory after this initialization procedure, the branch target buffer may need to be flushed and re-initialized as it may contain branch prediction for the code that previously existed at the modified locations.

4.3 Crossbar switch

In most cases, the crossbar settings can be left at their reset defaults. By knowing certain things about the application behavior and use of different masters on the crossbar, it is possible to customize priorities and use algorithms accordingly to obtain some slight performance improvements. For example, DMA transfers may benefit from a higher priority setting than the CPU load/store when communicating with the peripheral bus. This would prevent DMA transfers from stalling if the CPU were to poll a status register in a peripheral. However, this is a specific case which may not apply for all applications. For details on how to configure the crossbar and the relevant registers, see the Crossbar Switch chapter of the MPC5777C reference manual.

5 Conclusion

This application note has presented some specific recommendations for initializing this device and optimizing some of the settings from their reset defaults. This is a starting point only. Other areas to consider include compiler optimization and efficient use of system resources such as DMA and cache. Consult the MPC5777C reference manual for additional information.

6 Code

The code examples in this section can be found on the Freescale website as a software download.
6.1 init.s file

```assembly
.vle
.globl __start
.section .rcw, ax
.long 0x015a0000
.long __start
.section .init,avx             # The "ax" generates symbols for debug

__start:
mfpir r5                    # Check core id
se_cmpi r5,0
se_bne pll_end              # Skip pll init if this is core 1

#***************************************************************************
# UPDATE HISTORY
# Revision    Author      Date          Description of change
# 1.0         B. Terry    11/12/2009    Initial version for MPC5674F.
# 1.1         D. Erazmus  12/14/2010    Ported to MPC5676R.
# 1.2         D. Erazmus  07/27/2011    Converted to VLE instruction set.
# 1.3         D. Erazmus  11/08/2011    Fixed error in BIUCR value.
# 2.0         D. Erazmus  12/12/2013    Ported to MPC5777C.
# 2.1         S. Becerra  06/09/2015    Progressive clock switching enabled.
#***************************************************************************
```
# RFDPHI1 = 0x0C
# RFDPHI = 0x03
# PREDIV = 0x5
# MFD = 0x48
    e_lis    r3,0xFFE7
    e_or2i    r3,0x4000
    e_lis    r4,0x6003
    e_or2i    r4,0x5048
    e_stw    r4,0x8(r3)

# Wait for stable XOSC
xosc_wait:
    e_lis    r3,0xC3F9
    e_lwz   r4,0xC(r3)     # load SIU_RSR
    e_andi. r4,r4,0x80
    se_beq xosc_wait

# Turn on PLL0 and wait for lock
    e_lis    r3,0xFFE7
    e_or2i    r3,0x4000
    e_li    r4,0x0300
    e_stw    r4,0(r3)
wait_for_pll0:
    e_lwz   r4,0x4(r3)     # load PLLDIG_PLL0SR
    e_andi. r4,r4,0x4
    se_beq  wait_for_pll0

# Program PLL1
# RFDPHI = 0x02
# MFD = 0x16
    e_lis    r4,0x0002
    e_or2i    r4,0x0016
    e_stw    r4,0x28(r3)

# Turn on PLL1 and wait for lock
    e_li    r4,0x0300
    e_stw    r4,0x20(r3)
wait_for_pll1:
    e_lwz   r4,0x24(r3)
    e_andi. r4,r4,0x4
    se_beq  wait_for_pll1

#******************************
# configure PCS
#******************************

# Configure PCS Switch Duration
# SDUR = 0x10
    e_lis    r3,0xFFE7
    e_lis    r4,0x1000
    e_stw    r4,0x700(r3)

# Configure PLL1 Divider Change Register
# INIT = 0x4DF
# RATE = 0x30
    e_lis    r3,0xFFE7
    e_lis    r4,0x04DF
    e_or2i    r4,0x0030
    e_stw    r4,0x710(r3)

# Configure PLL1 Divider End Register
# DIVE = 0x4073
    e_lis    r3,0xFFE7
    e_li    r4,0x4073
    e_stw    r4,0x714(r3)

# Configure PLL1 Divider Start Register
# DIVS = 0x45B7
    e_lis    r3,0xFFE7
    e_li    r4,0x45B7

Select clock dividers and sources

- PLL0 ref = XOSX
- PLL1 ref = PLL0 PHI1
- PERCLKSEL = PLL1
- PBPDIV = Divide-by-2
- MCANSEL = XOSC
- SYSCLKSEL = PLL1
- ETPUDIV = Divide-by-1
- SYSLKDIV = Divide-by-1
- PCS = Enabled

configure the MMU

Note 1: When core 1 is running this same code it may not have executed BAM at all.

Note 2: configure TLB1 and TLB3 first before TLB0 since core 1 may be running
from RAM or Flash with the default 4k TLB0 page out of reset.

Note 3: Flash TLB covers non-contiguous flash array space and so is larger than 8M.

TLB1 = internal flash @ 0x0000_0000, VLE

TLB3 = internal SRAM @ 0x4000_0000, VLE, Write-Through Cache

TLB0 = pbridgeB @ 0xFFE0_0000, Cache inhibited, Guarded
e_or2i   r3,0x000A
mtspr   mas2,r3
e_lis   r3,0xFFE0
e_or2i   r3,0x003F
mtspr   mas3,r3
tlbwe

#TLB2 = external bus @ 0x2000_0000, VLE
  e_lis   r3,0x1002
  mtspr   mas0,r3
e_lis   r3,0xC000
e_or2i   r3,0x0700
  mtspr   mas1,r3
e_lis   r3,0x0200
e_or2i   r3,0x0020
  mtspr   mas2,r3
e_lis   r3,0x0000
e_or2i   r3,0x003F
  mtspr   mas3,r3
tlbwe

#TLB4 = pbridgeA @ 0xC3E0_0000, Cache inhibited, Guarded
  e_lis   r3,0x1004
  mtspr   mas0,r3
e_lis   r3,0xC000
e_or2i   r3,0x0580
  mtspr   mas1,r3
e_lis   r3,0xC3E0
e_or2i   r3,0x000A
  mtspr   mas2,r3
e_lis   r3,0xC3E0
e_or2i   r3,0x003F
  mtspr   mas3,r3
tlbwe

#TLB5 = 4k stack for each core (will be locked in cache)
  # (Note: located just after 512k TLB3 entry for SRAM)
  e_lis   r3,0x1005
  mtspr   mas0,r3
e_lis   r3,0xC000
e_or2i   r3,0x0180
  mtspr   mas1,r3
e_lis   r3,0x0400
e_or2i   r3,0x0000
  mtspr   mas2,r3
e_lis   r3,0x0408
e_or2i   r3,0x003F
  mtspr   mas3,r3
tlbwe

******************************************************************************
# invalidate and enable the data and instruction caches
******************************************************************************
# data cache
  e_lis   r3,0x0010
  e_or2i   r3,0x0003
  mtspr   l1csr0,r3
# inst cache
  e_lis   r3,0x0
  e_or2i   r3,0x0003
  mtspr   l1csr1,r3

******************************************************************************
# Enable SPE
******************************************************************************
mfmsr   r6
e_or2is   r6, 0x0200
mtmsr   r6

******************************************************************************
# initialize 512k SRAM  
# (core 0 only)

```
mfpir r5  
se_cmpi r5,0  
se_bne flashopt_end  
```

# Check core id

# Store number of 128Byte (32GPRs) segments in Counter
```
e_lis r5, _SRAM_SIZE@h  
e_or2i r5, _SRAM_SIZE@l  
e_srwi r5, r5, 0x7  
mtctr r5  
```

# Divide SRAM size by 128

# Move to counter for use with "bdnz"

# Base Address of the internal SRAM
```
e_lis r5, _SRAM_BASE_ADDR@h  
e_or2i r5, _SRAM_BASE_ADDR@l
```

# Fill SRAM with writes of 32GPRs
```
sram_loop:
  e_stmw r0,0(r5)  
  e_addi r5,r5,128  
  e_bdnz sram_loop  
```

# Loop for all of SRAM

#****************************

# Optimize Flash
#****************************

# Code is copied to RAM first, then executed, to avoid executing code from flash
# while wait states are changing.

```
se_b copy_to_ram  
```

# settings for 132MHz platform
```

FFCR1 = 0x00018317
P0_M8PFE = 0b0  (Core 0 Nexus master pre-fetch disabled)
P0_M0PFE = 0b1  (Core 0 master pre-fetch enabled)
P0_MxPFE = 0b0  (All other masters N/A port 0, disable)
APC = 0b100    (APC disabled and 1 wait state added per Errata 7422)
RWSC = 0b011   (3 additional hold cycles)
P0_DPFEN = 0b0  (Port0 data pre-fetch disabled)
P0_IPFEN = 0b1  (Port0 instruction pre-fetch enabled)
P0_PFLIM = 0b1x (prefetch on miss or hit)
P0_BFEN = 0b1   (read line buffer enabled)
```

FFCR2 = 0x00020017
P1_MxPFE = 0b0  (All other masters N/A port 1, disable)
P1_M9PFE = 0b0  (Core 1 Nexus master pre-fetch disabled)
P1_M8PFE = 0b0  (Core 0 Nexus pre-fetch N/A port 1, disable)
P1_M6PFE = 0b0  (SIP master pre-fetch disabled)
P1_M5PFE = 0b0  (eDMA_B master pre-fetch disabled)
P1_M4PFE = 0b0  (eDMA_A master pre-fetch disabled)
P1_M3PFE = 0b0  (CSE master pre-fetch disabled)
P1_M2PFE = 0b0  (FEC master pre-fetch disabled)
P1_M1PFE = 0b1  (Core 1 master pre-fetch enabled)
P1_M0PFE = 0b0  (Core 0 master pre-fetch N/A port 1, disable)
P1_DPFEN = 0b0  (data pre-fetch disabled)
P1_IPFEN = 0b1  (instruction pre-fetch enabled)
P1_PFLIM = 0b1x (prefetch on miss or hit)
P1_BFEN = 0b1   (read line buffer enabled)
```

flash_opt:
```
e_lis r3,0x0001  
e_or2i r3,0x8317  
e_lis r4,0xFFF6  
e_or2i r4,0x8000  
e_stw r3,0(r4)  
```

# FFCR1

```
e_lis r3,0x0002  
e_or2i r3,0x0017  
```
e_stw r3,4(r4)  # PFCR2
se_isync
msync
se_blr

copy_to_ram:
e_lis r3,flash_opt@h
e_or2i r3,flash_opt@l
e_lis r4,copy_to_ram@h
e_or2i r4,copy_to_ram@l
subf r4,r3,r4
se_mtctr r4
e_lis r5,0x4000
se_mtlr r5
copy:
e_lbz r6,0(r3)
e_stb r6,0(r5)
e_addi r3,r3,1
e_addi r5,r5,1
e_bdnz copy
se_isync
msync
se_blrl

flashopt_end:

#****************************
# enable BTB
#****************************
e_li r3, 0x0201
mtspr 1013, r3
se_isync

#******************************
# lock the stack into cache and set stack pointer (core 1)
#******************************
mfpir r5                  # Check core id
se_cmpi r5,0
se_beq stack_cache_0

stack_cache_1:
e_lis r3,__STACK_SIZE_1@h
e_or2i r3,__STACK_SIZE_1@l
se_srwi r3,5              # Shift the contents of R5 right by 5 bits (size/32)
se_mtctr r3
e_lis r3,__SP_END_1@h
e_or2i r3,__SP_END_1@l

lock_cache_loop_1:
dcbz r0,r3             # Establish address in cache for 32 bytes and zero
dcbtls 0,r0,r3          # Lock the address into the cache
se_addi r3,32           # Increment to start of next cache line (+32 bytes)
e_bdnz lock_cache_loop_1 # Decrement the counter (CTR), branch if nonzero
e_lis r1,(__SP_INIT_1-0x10)&h
e_or2i r1,(__SP_INIT_1-0x10)&l

# Set up stack and run time environment Core 1 ---------
e_lis r1, __SP_INIT_1@h  # Initialize stack pointer r1 to
e_or2i r1, __SP_INIT_1@l  # value in linker command file.
e_lis r13, __SDA_BASE @h  # Initialize r13 to sdata base
e_or2i r13, __SDA_BASE@l  # (provided by linker).
e_lis r2, __SDA2_BASE @h  # Initialize r2 to sdata2 base
e_or2i r2, __SDA2_BASE@l  # (provided by linker).
e_stwu r0,-64(r1)            # Terminate stack.
e_b main
# lock the stack into cache and set stack pointer (core 0)

```
stack_cache_0:
e_lis     r3, __STACK_SIZE_0@h
se_or2i    r3, __STACK_SIZE_0@l
se_srwi   r3, 5              # Shift the contents of R5 right by 5 bits (size/32)
se_mtctr  r3
se_addi   r3, 32             # Increment to start of next cache line (+32 bytes)
lock_cache_loop_0:
dcbz      r0, r3             # Establish address in cache for 32 bytes and zero
se_bdnz   lock_cache_loop_0   # Decrement the counter (CTR), branch if nonzero
```

# call ghs init code ( _start in crt0.s) This
# call to the GHS code insures heap etc. are
# configured and initialized correctly.

```
e_b _start

# hang if here
loop_forever:
  se_b loop_forever
```

### 6.2 main.c file

```
#include <ppc_ghs.h>
#include "MPC577xC.h"
#include "siu.h"
#define RSTVEC_VLE         1
#define RSTVEC_RESET     0x2
#define RSTVEC_RST_MASK 0xFFFFFFFC

Global vars

extern unsigned long __start;
extern unsigned long __SP_INIT_0-0x10)
extern unsigned long __SP_END_0+
```
int main (void)
{
    int pid;
    asm ("e_li    r0, 0x4000");
    asm ("mthid0 r0");                /* enable TB and decremender */
    pid = __MFSPR(286);
    if (pid == 0)
    {
        volatile int i;
        SIU.PCR[144].R = ALT0 | OBE;  //PA=0, OBE=1 for GPIO[0] PA[1]
        /* Start Core 1 in VLE mode */
        SIU.RSTVEC1.R = ((__unsigned long)__start & RSTVEC_RST_MASK) | RSTVEC_VLE;
        while (1)    /* loop forever (core 0) */
        {
            i++;
            if (i % 1000000 == 0)
            {
                SIU.GPDO[144].R ^= 1;
            }
        }
    } else {
        volatile int i;
        SIU.PCR[113].R = ALT0 | OBE;  //PA=0, OBE=1 for GPIO[0] PA[0]
        while (1)    /* loop forever (core 1) */
        {
            i++;
            if (i % 1000000 == 0)
            {
                SIU.GPDO[113].R ^= 1;
            }
        }
    }
} /* end of main */

6.3 Linker definition file

// ***********************************************************************
// FILE: standalone_romrun.ld                                             *
// DESCRIPTION:                                                         *
// Linker definition file for MPC5777C project                          *
//************************************************************************
// UPDATE HISTORY                                                       *
// Revision    Author      Date          Description of change           *
// 1.0         D. Erasmus  12/13/2010    Initial version for MPC5776R.  *
// 2.0         D. Erasmus  12/13/2013    Adapted for MPC5777C.           *
//************************************************************************
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// All Rights Reserved                                                  *
//*********************************************************************************

DEFAULTS {
    SRAM_SIZE       = 512K
    SRAM_MMU_SIZE   = 512K
    SRAM_BASE_ADDR  = 0x40000000
}
STACK_SIZE_0 = 4K                        // 4KB Stack for core 0
STACK_SIZE_1 = 4k                        // 4KB Stack for core 1

stack_reserve = 4k
heap_reserve  = 4k

MEMORY {
// 6M Internal Flash
flash_rsvd1 : ORIGIN = 0x00000000, LENGTH = 8
flash_memory1 : ORIGIN = .,              LENGTH = 256K-8
flash_rsvd2 : ORIGIN = 0x00800000, LENGTH = 8
flash_memory2 : ORIGIN = .,              LENGTH = 8M-8

// 512KB of internal SRAM starting at 0x40000000
dram_rsvd1 : ORIGIN = 0x40000000, LENGTH = 0x200
dram_reset : ORIGIN = .,                  LENGTH = 0
dram_memory : ORIGIN = .,                 LENGTH = SRAM_SIZE-0x200

// 4k of stack per core to be locked in cache
stack_ram0 : ORIGIN = SRAM_BASE_ADDR+SRAM_MMU_SIZE, LENGTH = STACK_SIZE_0
stack_ram1 : ORIGIN = SRAM_BASE_ADDR+SRAM_MMU_SIZE+STACK_SIZE_0, LENGTH = STACK_SIZE_1
}

// Program layout for starting in ROM, copying data to RAM,
// and continuing to execute out of ROM.
//

SECTIONS {
// RAM SECTIONS

.PPC.EMB.sdata0 ABS : > dram_memory
.PPC.EMB.sbss0 CLEAR ABS : > .

.sdbase ALIGN(16) : > dram_memory
.sdata : > .
.sbss : > .
.data : > .
.bss : > .
.heap ALIGN(16) PAD(heap_reserve) : > .
.__exception_handlers ALIGN(4k) : > .

.stack ALIGN(16) PAD(STACK_SIZE_0) : {} > stack_ram0 // Stack Area
.stack1 ALIGN(16) PAD(STACK_SIZE_1) : {} > stack_ram1 // Stack Area

// ROM SECTIONS

.rcw NOCHECKSUM : > flash_rsvd2
.init : {*.(init) } > flash_memory2
.text : > .
.vlextxt : > .
.syscall : > .
.rodata : > .
.sdata2 : > .

.secinfo : > .
.fixaddr : > .
.fixtype : > .

.CROM.PPC.EMB.sdata0 CROM(.PPC.EMB.sdata0) : > .
CROM.sdata                     CROM(.sdata) : > .
.CROM.data                      CROM(.data) : > .

/* Stack Address Parameters */
__SP_INIT       = ADDR(.stack) + SIZEOF(stack_ram0);
__SP_INIT_0     = ADDR(.stack) + SIZEOF(stack_ram0);
__SP_INIT_1     = ADDR(.stack1) + SIZEOF(stack_ram1);
__SP_END        = ADDR(.stack);
__SP_END_0      = ADDR(.stack);
__SP_END_1      = ADDR(.stack1);
__STACK_SIZE    = SIZEOF(stack_ram0);
__STACK_SIZE_0  = SIZEOF(stack_ram0);
__STACK_SIZE_1  = SIZEOF(stack_ram1);
__SRAM_BASE_ADDR = ADDR(dram_rsvd1);
__SRAM_SIZE     = SIZEOF(dram_rsvd1) + SIZEOF(dram_reset) + SIZEOF(dram_memory) +
SIZEOF(dram_rsvd2);

//
// These special symbols mark the bounds of RAM and ROM memory.
// They are used by the MULTI debugger.
//
__ghs_ramstart  = MEMADDR(dram_rsvd1);
__ghs_ramend    = MEMENDADDR(dram_memory);
__ghs_romstart  = MEMADDR(flash_rsvd1);
__ghs_romend    = MEMENDADDR(flash_rsvd2);

//
// These special symbols mark the bounds of RAM and ROM images of boot code.
// They are used by the GHS startup code (_start and __ghs_ind_crt0).
//
__ghs_rambootcodestart  = 0;
__ghs_rambootcodeend    = 0;
__ghs_rombootcodestart  = ADDR(.text);
__ghs_rombootcodeend    = ENDADDR(.fixtype);
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